IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: Toshio TAKAYAMA, et al.

Serial Number: Not Yet Assigned

Filed: December 16, 2003

For.: SEMICONDUCTOR DEVICE HAVING A MULTILAYER INTERCONNECTION STRUCTURE AND FABRICATION PROCESS THEREOF

INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

December 16, 2003

Sir:

In compliance with 37 CFR 1.56, Applicants call to the attention of the Patent and Trademark

Office the references listed on the attached PTO-1449.

A copy of each of the references is enclosed herewith.

In the event there are any fees due in connection with the filing of this paper, please charge Deposit Account No. <u>01-2340</u>.

Respectfully submitted,

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PATENT TRADEMARK OFFICE

Enclosures: PTO-1449; References (3)

INFORMATION DISCLOSURE STATEMENT PTO-1449			Atty. Docket No. 031325			Serial No.	Serial No. New Application		
			Applicant(s): Toshio TAKAYAMA, et al.						
			Filing D	Date: Decemb	per 16, 2003	Group Art 1	Group Art Unit: Not Yet Assigned		
U.S. PATENT DOCUMENTS									
Examiner Docum Initial			nent No. Name		Date	Class	Subclass	Filing Date (If appropriate)	
	AA								
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FOREIGN PATENT DOCUMENTS									
Docur			nent No.	Date	Country	Translation (Yes or No)			
	AE 2001-9		93976	04/06/01	Japan	Yes-Abstract			
	AF	AF 11-875		01/12/99	Japan	Yes-Abstract			
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